

HD74LS136

Quadruple 2-Input Exclusive-OR Gates (with open collector outputs)

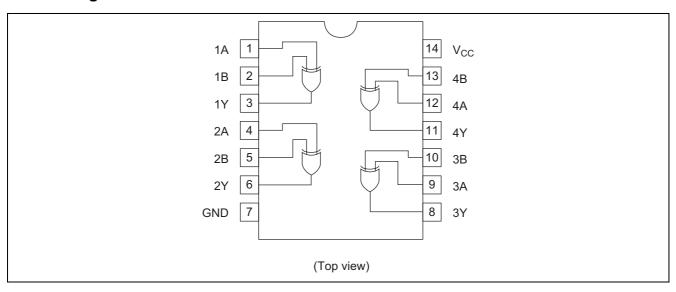
REJ03D0433-0300 Rev.3.00 Jul.13.2005

Features

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS136FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)

Pin Arrangement



Function Table

Inp	Output	
Α	В	Υ
L	L	L
L	Н	Н
Н	L	Н
Н	Н	L

Note: H; high level, L; low level, X; irrelevant.

Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	V _{CC}	7	V
Input voltage	V _{IN}	7	V
Power dissipation	P _T	400	mW
Storage temperature	Tstg	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	V _{CC}	4.75	5.00	5.25	V
High level output voltage	V _{OH}	_	_	5.5	V
Low level output current	I _{OL}	_	_	8	mA
Operating temperature	Topr	-20	25	75	°C

Electrical Characteristics

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltage	V _{IH}	2.0	_	_	V	
input voitage	V _{IL}	_	_	0.8	V	
Output current	I _{OH}	_	_	100	μΑ	$V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V}, V_{IL} = 0.8 \text{ V},$ $V_{OH} = 5.5 \text{ V}$
Output voltage	V _{OL}	_	_	0.4	V	$I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V},$
		_	_	0.5	V	$I_{OL} = 8 \text{ mA}$ $V_{IL} = 0.8 \text{ V},$
	I _{IH}	_	_	40	μΑ	$V_{CC} = 5.25 \text{ V}, V_{I} = 2.7 \text{ V}$
Input current	I _{IL}	_	_	-0.8	mA	$V_{CC} = 5.25 \text{ V}, V_{I} = 0.4 \text{ V}$
	I _I	_	_	0.2	mA	$V_{CC} = 5.25 \text{ V}, V_{I} = 7 \text{ V}$
Supply current**	I _{CC}	_	6.1	10	mA	V _{CC} = 5.25 V
Input clamp voltage	V_{IR}	_	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$

Notes: $^*V_{CC} = 5 \text{ V}$, Ta = 25°C

Switching Characteristics

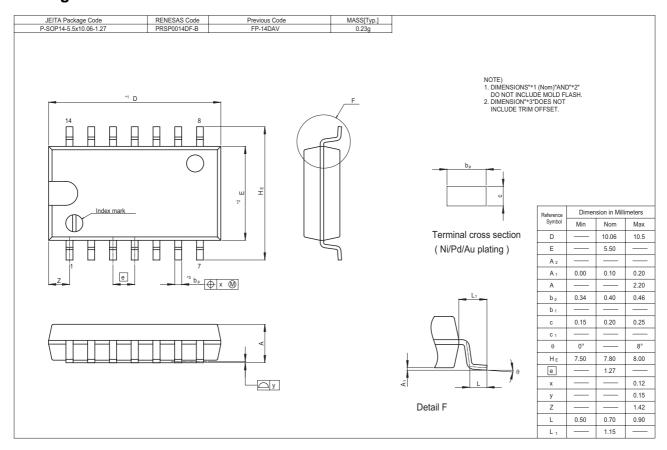
 $(V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C})$

Item	Symbol	min.	typ.	max.	Unit	Inputs	Condition	
Propagation delay time	t _{PLH}		18	30	ns	A or B	Other	C _L = 15 pF,
	t _{PHL}	_	18	30			inputs "L"	
	t _{PLH}	_	18	30	ns	A or B	Other	$R_L = 2 k\Omega$
	t _{PLH}	_	18	30	115	AUB	inputs "H"	

Note: Refer to Test Circuit and Waveform of the Common Item "TTL Common Matter (Document No.: REJ27D0005-0100)".

 $^{^{**}}$ I_{CC} is measured with one input of each gate at 4.5 V, the other inputs grounded, and the outputs open.

Package Dimensions



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